

Name : .....

Roll No. : .....

Invigilator's Signature : .....

**CS/B.Tech (ME/PE)/SEM-7/ME-701/2010-11**

**2010-11**

**ADVANCED MANUFACTURING TECHNOLOGY**

Time Allotted : 3 Hours

Full Marks : 70

*The figures in the margin indicate full marks.*

*Candidates are required to give their answers in their own words  
as far as practicable*

**GROUP – A**

**( Multiple Choice Type Questions )**

1. Choose the correct alternatives for any *ten* of the following :

10 × 1 = 10

- i) Which item best describes a CAM technology ?
  - a) Numerical control      b) Documentation
  - c) Drafting                      d) Geometric modelling.
  
- ii) Group technology brings together and organizes
  - a) Common parts, problems and tasks
  - b) Automation and tool production
  - c) Documentation and analysis
  - d) Parts and simulation analysis.

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- iii) The real brain of artificial intelligence is
  - a) Recursive technology
  - b) Bubble memory
  - c) The expert system
  - d) Scotopic system.
  
- iv) The integration of CAD and CAM is
  - a) CIM
  - b) CAE
  - c) CNC
  - d) Robots.
  
- v) CAM and CAM are linked through
  - a) A common databas and communication system
  - b) NC tape programming and automated design
  - c) Assembly automation and tool production
  - d) Parts production and testing.
  
- vi) MRR in ECM depends on
  - a) Hardness of work material
  - b) Atomic weight of work material
  - c) Thermal conductivity of work material
  - d) Ductility of work material.



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- xi) EBM is operated at
- a) Atmospheric pressure
  - b) At 1.2 bar pressure above atmosphere
  - c) At 10 – 100 m Torr pressure
  - d) At 0.01 – 0.001 m Torr pressure.

**GROUP – B**

**( Short Answer Type Questions )**

Answer any *three* of the following  $3 \times 5 = 15$

- 2. What is cloud point data in CAD ?
- 3. What do you mean by Compute Aided Inspection ?
- 4. How does chip formation take place in High Speed Machining ?
- 5. Mention the different types of flexibility in FMS.
- 6. Explain the concept of Variant CAPP method.

**GROUP – C**

**( Long Answer Type Questions )**

Answer any *three* of the following.  $3 \times 15 = 45$

- 7. a) What is LASER ? Describe the various types of LASER.
- b) Describe the working principle of Laser Beam Machining ( LBM ). What are the major applications of LBM ?

( 2 + 3 ) + ( 6 + 4 )

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8. a) What is production flow analysis ( PFA ) ? Explain the procedural steps in PFA.
- b) Describe the applications of Group Technology ( GT ) briefly.
- c) Apply the rank order clustering technique to the part-machine incidence matrix in the foll wing table to identify logical part families and machine groups. Parts are identified by letters and machines are identified numerically :

	<b>A</b>	<b>B</b>	<b>C</b>	<b>D</b>	<b>E</b>
<b>1</b>	1	0	0	0	0
<b>2</b>	0	1	0	0	1
<b>3</b>	1	0	0	1	0
<b>4</b>	0	1	1	0	0
<b>5</b>	0	0	0	1	0

5 + 5 + 5

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9. a) What is electrolysis ? How is it used in Electrochemical Machining ( ECM ) process ?

b) An alloy consists ( % by weight ) of nickel ( 72% ), chromium ( 20% ), iron ( 5 % ), titanium ( 0.5% ), copper ( 0.5% ), silicon and manganese ( 1.0% each ). The required data have been given in the following table :

Metal	Gram atomic weight	Valency of dissolution ( lowest )	Density ( $\text{g/cm}^3$ )
Nickel	58.71	2	8.90
Chromium	51.99	2	7.19
Iron	55.85	2	7.86
Titanium	47.90	3	4.51
Silicon	28.09	4	2.33
Manganese	54.94	2	7.43
Copper	63.7	1	8.96

i) Determine the material removal rate ( in  $\text{cm}^3/\text{min}$  ) when a current of 1000 amp is passed in ECM operation.

ii) In an ECM operation, the workpiece is of pure iron. Determine the equilibrium gap with the following data :

Supply voltage = 10V, total over potential = 1.5V,  
conductivity of electrolyte =  $0.2 \text{ ohm}^{-1}\text{cm}^{-1}$ ,  
feed rate = 1 mm/min.

( 3 + 4 ) + ( 5 + 3 )

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10. a) Explain the sequence of fabrication in Rapid prototyping.
- b) Describe with a neat sketch, Solid Ground Curing.
- c) Differentiate between hard automation and soft automation. 5 + 5 + 5
11. Write short notes on any *three* of the following : 5 + 5 + 5
- a) Coordinate measuring machine
- b) Computer Integrated Manufacturing
- c) Computer Networking.
- d) Computer Aided Quality Control.
12. a) Elucidate the various facets of an expert system in relation to artificial intelligence.
- b) Explain the various types of networking methods used for data transmission.
- c) Discuss the limitations of reverse engineering with examples known to you. 5 + 5 + 5

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